## Meets or Exceeds the Requirements of TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendations V. 11 and X. 27

- Recommended for PROFIBUS Applications
- Operates at Data Rates up to 35 MBaud
- Operating Temperature Range $\ldots-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
- Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments
- Low Supply-Current Requirement ... 30 mA Max
- Wide Positive and Negative Input/Output Bus-Voltage Ranges
- Thermal-Shutdown Protection
- Driver Positive- and Negative-Current Limiting
- Receiver Input Hysteresis
- Glitch-Free Power-Up and Power-Down Protection
- Receiver Open-Circuit Fail-Safe Design
- Package Options Include Plastic Small-Outline (D) Package and (P) DIPs


## description

d $\quad$ OR P PACKAGE
(TOP VIEW)

$\dagger$ The D package is available taped and reeled. Add the suffix R to the device type (e.g., SN65ALS1176DR).

The SN65ALS1176 differential bus transceiver is designed for bidirectional data communication on multipoint bus transmission lines. It is designed for balanced transmission lines and meets TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendations V. 11 and X. 27.
The SN65ALS1176 combines a 3-state differential line driver and a differential input line receiver, both of which operate from a single 5-V power supply. The driver and receiver have active-high and active-low enables, respectively, that can be connected together externally to function as a direction control. The driver differential outputs and the receiver differential inputs are connected internally to form a differential input/output (I/O) bus port that is designed to offer minimum loading to the bus when the driver is disabled or $\mathrm{V}_{\mathrm{CC}}=0$. This port features wide positive and negative common-mode voltage ranges, making the device suitable for party-line applications.

The SN65ALS1176 is characterized for operation from $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$.

## Function Tables

| DRIVERS |  |  |  |
| :---: | :---: | :---: | :---: |
| INPUT ENABLE   <br> D DE OUTPUTS  <br>  A B  <br> $H$ $H$ $H$  <br> L    <br> L $H$ L  <br> X L Z  |  |  |  |

RECEIVER

| DIFFERENTIAL INPUTS <br> $\mathbf{A}-\mathbf{B}$ | ENABLE <br> $\overline{R E}$ | OUTPUT <br> $\mathbf{R}$ |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{ID}} \geq 0.2 \mathrm{~V}$ | L | H |
| $-0.2 \mathrm{~V}<\mathrm{V}_{\mathrm{ID}}<0.2 \mathrm{~V}$ | L | $?$ |
| $\mathrm{~V}_{\mathrm{ID}} \leq-0.2 \mathrm{~V}$ | L | L |
| X | H | Z |
| Inputs open | L | H |

$H$ = high level, $L=$ low level, $X=$ irrelevant,
? = Indeterminate, $\mathrm{Z}=$ high impedance (off)
logic symbol $\dagger$

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
logic diagram (positive logic)


## schematics of inputs and outputs

EQUIVALENT OF EACH INPUT

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$

Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ (see Note 1) ............................................................................ 7 . 7
Voltage range at any bus terminal ................................................................... 7 V to 12 V

Package thermal impedance, $\theta_{\mathrm{JA}}$ (see Note 2): D package ...................................... $97^{\circ} \mathrm{C} / \mathrm{W}$
P package ......................................... $85^{\circ} \mathrm{C} / \mathrm{W}$


$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. All voltage values, except differential I/O bus voltage, are with respect to network ground terminal.
2. The package thermal impedance is calculated in accordance with JESD 51.

## recommended operating conditions

|  |  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ |  | 4.75 | 5 | 5.25 | V |
| Input voltage at any bus terminal (separately or common mode), $\mathrm{V}_{\text {I }}$ or $\mathrm{V}_{\text {IC }}$ |  |  |  | 12 | V |
|  |  |  |  | -7 |  |
| High-level input voltage, $\mathrm{V}_{\mathrm{IH}}$ | D, DE, and $\overline{R E}$ | 2 |  |  | V |
| Low-level input voltage, $\mathrm{V}_{\text {IL }}$ | D, DE, and $\overline{\mathrm{RE}}$ |  |  | 0.8 | V |
| Differential input voltage, $\mathrm{V}_{\text {ID }}$ (see Note 3) |  |  |  | $\pm 12$ | V |
| High-level output current, IOH | Driver |  |  | -60 | mA |
|  | Receiver |  |  | -400 | $\mu \mathrm{A}$ |
| Low-level output current, IOL | Driver |  |  | 60 | mA |
|  | Receiver |  |  | 8 |  |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ |  | -25 |  | 85 | ${ }^{\circ} \mathrm{C}$ |

NOTE 3: Differential input/output bus voltage is measured at the noninverting terminal A with respect to the inverting terminal B .

## DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS $\dagger$ |  | MIN TYP\# | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IK }}$ | Input clamp voltage | $\boldsymbol{I}=-18 \mathrm{~mA}$ |  |  | -1.5 | V |
| $\mathrm{V}_{\mathrm{O}}$ | Output voltage | $\mathrm{I}=0$ |  | 0 | 6 | V |
| \|VOD1 ${ }^{\text {l }}$ | Differential output voltage | $\mathrm{O}=0$ |  | 1.5 | 6 | V |
| \|VOD2| | Differential output voltage | $\mathrm{R}_{\mathrm{L}}=100 \Omega$, | See Figure 1 | $1 / 2 \mathrm{~V}_{\text {OD } 1}$ or $2 \S$ |  | V |
|  |  | $\mathrm{R}_{\mathrm{L}}=54 \Omega$, | See Figure 1 | 2.12 .5 | 5 | V |
| VOD3 | Differential output voltage | $\mathrm{V}_{\text {test }}=-7 \mathrm{~V}$ to 12 V , | See Figure 2 | 1.5 | 5 | V |
| $\Delta\left\|\mathrm{V}_{\text {OD }}\right\|$ | Change in magnitude of differential output voltage ${ }^{\\|}$ | $R_{L}=54 \Omega$ or $100 \Omega$, | See Figure 1 |  | $\pm 0.2$ | V |
| VOC | Common-mode output voltage |  |  |  | 3 | V |
| $\Delta \mid \mathrm{VOCl}$ | Change in magnitude of common-mode output voltage ${ }^{\text {I }}$ |  |  |  | $\pm 0.2$ | V |
| 10 | Output current | Outputs disabled, See Note 4 | $\mathrm{V}_{\mathrm{O}}=12 \mathrm{~V}$ |  | 1 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{O}}=-7 \mathrm{~V}$ |  | -0.8 |  |
| IIH | High-level input current | $\mathrm{V}_{\mathrm{I}}=2.4 \mathrm{~V}$ |  |  | 20 | $\mu \mathrm{A}$ |
| IIL | Low-level input current | $\mathrm{V}_{1}=0.4 \mathrm{~V}$ |  |  | -400 | $\mu \mathrm{A}$ |
| Ios | Short-circuit output current\# | $\mathrm{V}_{\mathrm{O}}=-4 \mathrm{~V}$ |  |  | -250 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=0$ |  |  | -150 |  |
|  |  | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}}$ |  |  | 250 |  |
|  |  | $\mathrm{V}_{\mathrm{O}}=8 \mathrm{~V}$ |  |  | 250 |  |
| ICC | Supply current | No load | Outputs enabled | 23 | 30 | mA |
|  |  |  | Outputs disabled | 19 | 26 |  |

$\dagger$ The power-off measurement in TIA/EIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.
$\ddagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
§ The minimum $\mathrm{V}_{\mathrm{OD} 2}$ with a $100-\Omega$ load is either $1 / 2 \mathrm{~V}_{\mathrm{OD} 1}$ or 2 V , whichever is greater.
II $\Delta\left|V_{O D}\right|$ and $\Delta \mid V_{O C l}$ are the changes in magnitude of $V_{O D}$ and $V_{O C}$, respectively, that occur when the input is changed from one logic state to the other.
\# Duration of the short circuit should not exceed one second for this test.
NOTE 4: This applies for both power on and power off; refer to TIA/EIA-485-A for exact conditions. The TIA/EIA-422-B limit does not apply for a combined driver and receiver terminal.
switching characteristics over recommended ranges of supply voltage and operating free-air temperature range

| PARAMETER | TEST CONDITIONS | MIN TYP† MAX | UNIT |
| :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{d}}(\mathrm{OD}) \quad$ Differential output delay time | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=54 \Omega, \\ & \text { See Figure } 3 \end{aligned} \quad \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF},$ | 15 | ns |
| $\mathrm{t}_{\text {sk(p) }}$ Pulse skew $\ddagger$ |  | $0 \quad 2$ | ns |
| $\mathrm{t}_{\mathrm{t}(\mathrm{OD})}$ Differential output transition time |  | 8 | ns |
| tPZH Output enable time to high level | $\mathrm{R}_{\mathrm{L}}=110 \Omega$, <br> See Figure 4$\quad \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, | 80 | ns |
| tPZL Output enable time to low level | $\mathrm{R} \mathrm{L}=110 \Omega$, <br> See Figure 5$\quad \mathrm{CL}=50 \mathrm{pF}$, | 30 | ns |
| tphz Output disable time from high level | $\begin{array}{\|ll} \hline \mathrm{R}_{\mathrm{L}}=110 \Omega, & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \\ \text { See Figure } 4 & \\ \hline \end{array}$ | 50 | ns |
| tplz Output disable time from low level | $\mathrm{R}_{\mathrm{L}}=110 \Omega$, <br> See Figure 5$\quad \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, | 30 | ns |

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$\ddagger$ Pulse skew is defined as the $|\mathrm{tPLH}-\mathrm{t} P \mathrm{HL}|$ of each channel of the same device.
SYMBOL EQUIVALENTS

| DATA-SHEET PARAMETER | TIA/EIA-422-B | TIA/EIA-485-A |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{V}_{\mathrm{Oa}}, \mathrm{V}_{\mathrm{Ob}}$ | $\mathrm{V}_{\mathrm{Oa}}, \mathrm{V}_{\mathrm{ob}}$ |
| $\left\|\mathrm{V}_{\mathrm{OD} 1}\right\|$ | $\mathrm{V}_{\mathrm{O}}$ | $\mathrm{V}_{\mathrm{O}}$ |
| $\left\|\mathrm{V}_{\mathrm{OD} 2}\right\|$ | $\left(\mathrm{R}_{\mathrm{L}}=100 \Omega\right)$ | $\mathrm{V}_{\mathrm{t}}\left(\mathrm{R}_{\mathrm{L}}=54 \Omega\right)$ |
| $\left\|\mathrm{V}_{\mathrm{OD} 3}\right\|$ | None | (test termination <br> measurement 2$)$ |
| $\Delta\left\|\mathrm{V}_{\mathrm{OD}}\right\|$ | $\left\|\left\|\mathrm{V}_{\mathrm{t}}\right\|-\left\|\overline{\mathrm{V}}_{\mathrm{t}}\right\|\right\|$ | $\left\|\left\|\mathrm{V}_{\mathrm{t}}\right\|-\left\|\overline{\mathrm{V}}_{\mathrm{t}}\right\|\right\|$ |
| $\mathrm{V}_{\mathrm{OC}}$ | $\left\|\mathrm{V}_{\mathrm{OS}}\right\|$ | $\left\|\mathrm{V}_{\mathrm{OS}}\right\|$ |
| $\Delta\left\|\mathrm{V}_{\mathrm{OC}}\right\|$ | $\left\|\mathrm{V}_{\mathrm{OS}}-\overline{\mathrm{V}}_{\mathrm{os}}\right\|$ | $\left\|\mathrm{V}_{\mathrm{OS}}-\overline{\mathrm{V}}_{\mathrm{OS}}\right\|$ |
| $\mathrm{I}_{\mathrm{OS}}$ | $\left\|\mathrm{I}_{\mathrm{sa}}\right\|,\left\|\left.\right\|_{\mathrm{sb}}\right\|$ | None |
| $\mathrm{I}_{\mathrm{O}}$ | $\left\|\mathrm{I}_{\mathrm{xa}}\right\|,\left\|\left.\right\|_{\mathrm{xb}}\right\|$ | $\mathrm{l}_{\mathrm{ia}}, \mathrm{l}_{\mathrm{ib}}$ |

## RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature range (unless otherwise noted)

| PARAMETER |  | TEST CONDITIONS |  | MIN | TYP $\dagger$ | MAX | $\frac{\mathrm{UNIT}}{\mathrm{~V}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IT }+}$ | Positive-going input threshold voltage | $\mathrm{V}_{\mathrm{O}}=2.7 \mathrm{~V}$, | $\mathrm{I} \mathrm{O}=-0.4 \mathrm{~mA}$ |  |  | 0.2 |  |
| $\mathrm{V}_{\text {IT- }}$ | Negative-going input threshold voltage | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$, | $\mathrm{I} \mathrm{O}=8 \mathrm{~mA}$ | $-0.2 \ddagger$ |  |  | V |
| $\mathrm{V}_{\text {hys }}$ | Hysteresis voltage ( $\mathrm{V}_{\text {IT }+}-\mathrm{V}_{\text {IT-}}$ ) |  |  |  | 60 |  | mV |
| $\mathrm{V}_{\text {IK }}$ | Enable-input clamp voltage | $\mathrm{I}_{\mathrm{I}}=-18 \mathrm{~mA}$ |  |  |  | -1.5 | V |
| V OH | High-level output voltage | $\mathrm{V}_{\mathrm{ID}}=200 \mathrm{mV},$ <br> See Figure 6 | $\mathrm{I}^{\mathrm{OH}}=-400 \mu \mathrm{~A}$, | 2.7 |  |  | V |
| VOL | Low-level output voltage | $\mathrm{V}_{\mathrm{ID}}=-200 \mathrm{mV} \text {, }$ <br> See Figure 6 | $\mathrm{IOL}=8 \mathrm{~mA},$ |  |  | 0.45 | V |
| loz | High-impedance-state output current | $\mathrm{V}_{\mathrm{O}}=0.4 \mathrm{~V}$ to 2.4 V |  |  |  | $\pm 20$ | $\mu \mathrm{A}$ |
| $\mathrm{V}_{1}$ | Line input current | Other input $=0 \mathrm{~V}$, | $\mathrm{V}_{1}=12 \mathrm{~V}$ |  |  | 1 | mA |
|  |  | See Note 5 | $\mathrm{V}_{\mathrm{I}}=-7 \mathrm{~V}$ |  |  | -0.8 |  |
| IIH | High-level-enable input current | $\mathrm{V}_{\mathrm{IH}}=2.7 \mathrm{~V}$ |  |  |  | 20 | $\mu \mathrm{A}$ |
| IIL | Low-level-enable input current | $\mathrm{V}_{\mathrm{IL}}=0.4 \mathrm{~V}$ |  |  |  | -100 | $\mu \mathrm{A}$ |
| rl | Input resistance |  |  | 12 | 20 |  | $\mathrm{k} \Omega$ |
| los | Short-circuit output current | $\mathrm{V}_{\mathrm{ID}}=200 \mathrm{mV}$, | $\mathrm{V}_{\mathrm{O}}=0$ | -15 |  | -85 | mA |
| ICC | Supply current | No load | Outputs enabled |  | 23 | 30 | mA |
|  |  |  | Outputs disabled |  | 19 | 26 |  |

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
$\ddagger$ The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.
NOTE 5: This applies for both power on and power off. Refer to TIA/EIA-485-A for exact conditions.
switching characteristics over recommended ranges of supply voltage and operating free-air temperature range

| PARAMETER | TEST CONDITIONS |  | MIN TYP $\dagger$ | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| tpd Propagation time | $\mathrm{V}_{\mathrm{ID}}=-1.5 \mathrm{~V} \text { to } 1.5 \mathrm{~V} \text {, }$ <br> See Figure 7 | $C_{L}=15 \mathrm{pF}$, |  | 25 | ns |
| $\left.\mathrm{t}_{\text {sk( }} \mathrm{p}\right) \quad$ Pulse skew§ |  |  | 0 | 2 | ns |
| tPZH Output enable time to high level | $C_{L}=15 \mathrm{pF}$, | See Figure 8 | 11 | 18 | ns |
| tPZL Output enable time to low level |  |  | 11 | 18 | ns |
| tphz Output disable time from high level |  |  |  | 50 | ns |
| tplz Output disable time from low level |  |  |  | 30 | ns |

$\dagger$ All typical values are at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$.
§ Pulse skew is defined as the |tpLH - tPHL| of each channel of the same device.

## PARAMETER MEASUREMENT INFORMATION



Figure 1. Driver $\mathrm{V}_{\mathrm{OD} 2}$ and $\mathrm{V}_{\mathrm{OC}}$ Test Circuit


Figure 2. Driver $\mathrm{V}_{\mathrm{OD} 3}$ Test Circuit


NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
$B$. The input pulse is supplied by a generator having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, 50 \%$ duty cycle, $\mathrm{t}_{\mathrm{r}} \leq 6 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 6 \mathrm{~ns}$, $Z_{O}=50 \Omega$.
C. $t_{d}(O D)=t_{d}(O D H)$ or $t_{d}(O D L)$

Figure 3. Driver Differential-Output Delay and Transition Times

## PARAMETER MEASUREMENT INFORMATION



NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: PRR $\leq 1 \mathrm{MHz}, 50 \%$ duty cycle, $\mathrm{t}_{\mathrm{r}} \leq 6 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 6 \mathrm{~ns}$, $Z_{O}=50 \Omega$.

Figure 4. Driver Enable and Disable Times


NOTES:
A. $C_{L}$ includes probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, 50 \%$ duty cycle, $\mathrm{t}_{\mathrm{r}} \leq 6 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 6 \mathrm{~ns}$, $Z_{\mathrm{O}}=50 \Omega$.

Figure 5. Driver Enable and Disable Times

## PARAMETER MEASUREMENT INFORMATION



Figure 6. Receiver $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ Test Circuit


NOTES: A. $\mathrm{C}_{\mathrm{L}}$ includes probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, 50 \%$ duty cycle, $\mathrm{t}_{\mathrm{r}} \leq 6 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 6 \mathrm{~ns}$, $Z_{O}=50 \Omega$.
C. $t_{p d}=t$ tPLH or tpHL

Figure 7. Receiver Propagation-Delay Times


NOTES: A. $C_{L}$ includes probe and jig capacitance.
B. The input pulse is supplied by a generator having the following characteristics: $\mathrm{PRR} \leq 1 \mathrm{MHz}, 50 \%$ duty cycle, $\mathrm{t}_{\mathrm{r}} \leq 6 \mathrm{~ns}, \mathrm{t}_{\mathrm{f}} \leq 6 \mathrm{~ns}$, $\mathrm{Z}_{\mathrm{O}}=50 \Omega$.

Figure 8. Receiver Output Enable and Disable Times

## APPLICATION INFORMATION



NOTE A: The line should terminate at both ends in its characteristic impedance ( $R_{T}=Z_{O}$ ). Stub lengths off the main line should be kept as short as possible.

Figure 9. Typical Application Circuit

## PACKAGING INFORMATION

| Orderable Device | Status <br> (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <br> (2) | Lead/Ball Finish <br> (6) | MSL Peak Temp <br> (3) | Op Temp ( ${ }^{\circ} \mathrm{C}$ ) | Device Marking <br> (4/5) | Samples |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN65ALS1176D | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS \& no $\mathrm{Sb} / \mathrm{Br}$ ) | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | 6A1176 | Samples |
| SN65ALS1176DR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS \& no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | -25 to 85 | 6A1176 | Samples |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.
${ }^{(3)}$ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
${ }^{(4)}$ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
${ }^{(5)}$ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
${ }^{(6)}$ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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## TAPE AND REEL INFORMATION



| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter $(\mathrm{mm})$ | $\begin{array}{\|c\|} \hline \text { Reel } \\ \text { Width } \\ \text { W1 }(\mathrm{mm}) \\ \hline \end{array}$ | A0 (mm) | B0 (mm) | K0 (mm) | $\begin{gathered} \mathrm{P} 1 \\ (\mathrm{~mm}) \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ (\mathrm{~mm}) \end{gathered}$ | Pin1 Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN65ALS1176DR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SN65ALS1176DR | SOIC | D | 8 | 2500 | 340.5 | 338.1 | 20.6 |



NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed . 006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.


SOLDER MASK DETAILS

NOTES: (continued)
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.


NOTES: (continued)
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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